

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









#### AMD GEODE™ CLOCK SOURCE

MK1491-06

### **Description**

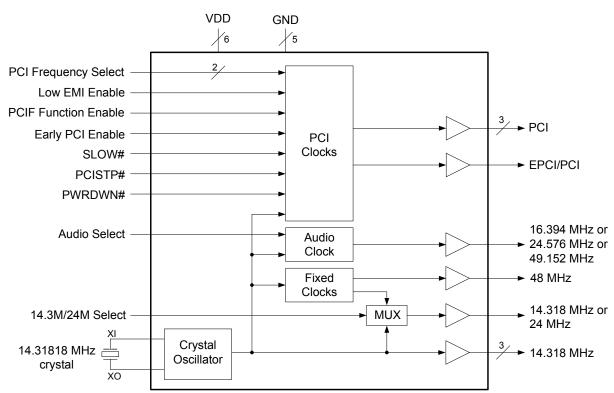
The MK1491-06 is a low-cost, low-jitter, high-performance clock synthesizer for AMD's Geode-based computer and portable appliance applications. Using patented analog Phased-Locked Loop (PLL) techniques, the device accepts a 14.318 MHz crystal input to produce multiple output clocks. It provides selectable PCI local bus and AC97 audio clocks, 24 MHz and 48 MHz clocks for Super I/O and USB, as well as multiple Reference outputs.

The device has multiple power-down modes to reduce power consumption.

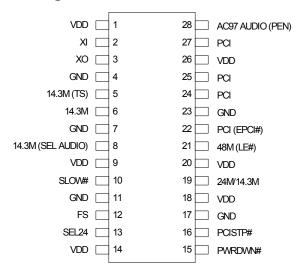
#### **Features**

- Packaged in 28-pin SOIC or in 28-pin SSOP
- · Available in Pb (lead) free
- Provides all critical timing for the AMD Geode companion chip
- Four PCI clocks
- Selectable PCIF on up to 2 outputs
- Early PCI clock selectability
- Up to 4 Reference clocks
- 48 MHz USB and 24MHz SIO support
- AC97 audio clock
- Multiple power down modes
- Low EMI Enable pin reduces EMI radiation on PCI clocks (patented)
- Operating voltage of 3.3 V ±5%

# **Block Diagram**



### **Pin Assignment**



### **Early PCI Control Table**

EPCI#	PCI (Pin 22)			
0	1 ns early			
1	Normal			

#### **EMI Control**

LE#	PCI Low EMI			
0	ON			
1	OFF			

Spread direction is DOWN.

#### **PCI Frequency Select Table**

TS	FS	PCI				
0	0	Tristate all clocks				
0	1	Reserved				
М	0	30 MHz				
М	1	33.3 MHz				
1	0	25 MHz				
1	1	37.5 MHz				

### 24M/14.3M Frequency Select Table

SEL24	24M/14.3M				
0	14.31818 MHz				
1	24.0 MHz				

#### **PCIF Enable Control**

PEN	Pin 25	Pin 24
0	PCI	PCI
М	PCI	PCIF
1	PCIF	PCIF

PCIF continues to run in PCI STOP mode. See table on page 4.

### **AC97 Audio Frequency Select**

SEL AUDIO	AC97 AUDIO
0	16.9344 MHz
М	24.576 MHz
1	49.152 MHz

## **Pin Descriptions**

Pin Number	Pin Name	Pin Type	Pin Description
1, 9, 14	VDD	Р	Connect to +3.3 V. Must be same voltage on all pins.
2	XI	1	Crystal connection. Connect to a 14.31818 MHz crystal or input clock.
3	XO	0	Crystal connection. Connect to a 14.31818 MHz crystal, or leave unconnected for clock.
4, 7, 11, 17, 23	GND	Р	Connect to Ground.
5	14.3M (TS)	TI/O	14.318 MHz output. Input control for all clocks per table above.
6	14.3M	0	14.318 MHz buffered reference clock output.

Pin Number	Pin Name	Pin Type	Pin Description		
8	14.3M (SEL AUDIO)	TI/O	14.318 MHz output and audio frequency select input per table above.		
10	SLOW#	I	PCI normal or slow mode select input per table on page 4.		
12	FS	I	Frequency Select for PCI clocks per table above.		
13	SEL24	I	Fixed frequency select input per table above. Selects frequency on pin 19.		
15	PWRDWN#	I	Power down control; defined in table on page 4.		
16	PCISTP#	I	PCI Stop power down control; defined in table on page 4.		
18, 20, 26	VDD	Р	Connect to +3.3 V. Must be same voltage on all pins.		
19	24M/14.3M	0	Fixed frequency clock output per table above.		
21	48 (LE#)	I/O	Fixed frequency clock output and low EMI (spread spectrum) enable input per table above.		
22	PCI (EPCI#)	I/O	PCI Output clock that can be early. Input control for Early PCI per table above.		
24	PCI	0	PCI Output clock. PCI/PCIF control set by PEN per table above.		
25	PCI	0	PCI Output clock. PCI/PCIF control set by PEN per table above.		
27	PCI	0	PCI Output clock.		
28	AC97 AUDIO (PEN)	TI/O	Audio clock output and PCIF Function Enable per table above.		

#### KEY:

I = Input

TI = Tri-level

O = Output

P = Power supply connection

(T)I/O = Input on power up, becomes an Output after 10 ms

Weak internal pull-up resistors are present on SEL24, EPCI#, FS, LE#, PCISTP#, and SLOW#. These pins should be tied to VDD or GND, and not be left floating. Internal resistors on PEN, SEL AUDIO, and TS pull to mid-level (M).

### **Power Down Control Table**

PCISTP#	PWRDWN#	SLOW#	MODE	PCI	PCIF	24/14.3	14.3	Description
Х	0	Х	Power down	LOW	LOW	LOW	LOW	All outputs low. PLL's and oscillators off.
0	1	Х	PCI STOP	LOW	ON	ON	ON	PCI clocks synchronously enter and leave low state.
1	1	Χ	ON	ON	ON	ON	ON	All clocks on.

Key: 1 = connected to VDD, 0 = connected to ground, X = any valid logic level, combination inputs/outputs should be connected to VDD or ground through a 10 k $\Omega$  resistor as shown below.

# **Power-on Default Conditions**

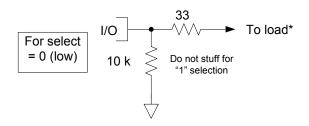
Pin #	Function	Default	Condition		
5	TS	М	All outputs enabled.		
8	SEL AUDIO	М	Audio clock (pin 28) set to 24.576 MHz		
10	SLOW#	1	PCI clocks set to 33.3 MHz. Refer to Power Down Control Table above.		
12	FS	1	PCI frequency = 33.3 MHz.		
13	SEL 24	1	24M/14.3M (pin 19) set to 24 MHz.		
15	PWRDWN#	1	All clocks running.		
16	PCISTP#	1	PCI clocks running.		
21	LE#	1	Low EMI function OFF		
22	EPCI#	1	Pin 22 set to normal PCI signal (not early).		
28	PEN	М	PCI (pin 25) set to PCI clock (33.33 MHz). PCI (pin 24) set to PCIF clock (33.33 MHz).		

### **External Components**

The MK1491-06 requires some inexpensive external components for proper operation. Decoupling capacitors of 0.1µF should be connected on each VDD pin to ground, as close to the MK1491-06 as possible. A series termination resistor of  $33\Omega$  may be used for each clock output. See the discussion below for other external resistors required for proper I/O operation. The 14.3 MHz oscillator has internal caps that provide the proper load for a parallel resonant crystal with CL=18 pF. For tuning with other values of C<sub>1</sub>, the formula 2\*(C<sub>1</sub>-18) gives the value of each capacitor that should be connected between X1 and ground and X2 and ground.

#### I/O Structure

The MK1491-06 provides more functionality in a 28-pin package by using a unique I/O technique. The device checks the status of all I/O pins during power-up and at exit from the Power Down state. This status (pulled high, low, or mid-level) then determines the frequency selections and power down modes (see the tables on pages 2 and 4). Within 10ms after power up, the inputs change to outputs and the clocks start up. In the diagrams to the right, the  $33\Omega$ resistors are the normal output termination resistors. The  $10k\Omega$  resistor pulls low to generate a logic zero. Weak internal pull-up resistors are present on SEL24, EPCI#, FS, LE#, PCISTP#, and SLOW#. These pins should be connected directly to VDD or GND if not under active control. Internal resistors on PEN, SEL AUDIO, and TS pull to a mid-level (M).



\*Note: Do not use a TTL load. This will overcome the 10 k $\Omega$ pull-down and force the input to a logic 1.

## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the MK1491-06. These ratings, which are standard values for ICS commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	7 V
All Inputs and Outputs	-0.5 V to VDD+0.5 V
Ambient Operating Temperature	0 to +70° C
Storage Temperature	-65 to +150° C
Junction Temperature	125° C
Soldering Temperature	260° C

### **Recommended Operation Conditions**

Parameter	Min.	Тур.	Max.	Units
Ambient Operating Temperature	0		+70	°C
Power Supply Voltage (measured in respect to GND)	+3.15	+3.3	+3.45	V

### **DC Electrical Characteristics**

Unless stated otherwise, **VDD = 3.3 V ±5%**, Ambient Temperature 0 to +70° C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Operating Voltage	VDD		3.15	3.3	3.45	V
Input High Voltage	V <sub>IH</sub>		2			V
Input Mid-level Voltage	V <sub>IM</sub>		1.2	1.4	1.6	V
Input Low Voltage	V <sub>IL</sub>				0.8	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -8 mA	2.4			V
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 8 mA			0.4	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -8 mA	VDD-0.4			V
Operating Supply Current	IDD	33 MHz, no load		30		mA
Power Down Mode Supply Current				15		μΑ
Short Circuit Current, SIngle Output Driver		VDD = 3.3 V		±60		mA
Input Capacitance	C <sub>IN</sub>			7		pF

### **AC Electrical Characteristics**

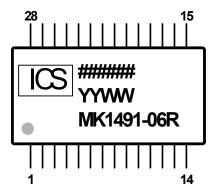
Unless stated otherwise, **VDD = 3.3 V \pm5%**, Ambient Temperature 0 to  $+70^{\circ}$  C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Input Frequency	F <sub>IN</sub>			14.31818		MHz
Output Clock Rise Time	t <sub>OR</sub>	20% to 80%			1.5	ns
Output Clock Fall Time	t <sub>OF</sub>	80% to 20%			1.5	ns
Output Clock Duty Cycle, all MHz Clocks	t <sub>OD</sub>	At 1.5 V	45	49 to 51	55	%
PCI Output to Output Skew		Rising edges at 1.5 V			500	ps
Skew of EPCI with respect to PCI				1		ns
Cycle-to-Cycle Jitter, PCI clocks				250		ps
EMI Reduction, peaks of 5th - 19th odd harmonics		33.3 MHz PCI Clock		6	11	dB
Power-up Time, PWRDWN# High to all Clocks Stable				8	20	ms
Power-on Time, applied VDD to all Clocks Stable				12	25	ms

# **Thermal Characteristics**

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to	$\theta_{JA}$	Still air		100		° C/W
Ambient	$\theta_{JA}$	1 m/s air flow		80		° C/W
	$\theta_{JA}$	3 m/s air flow		67		° C/W
Thermal Resistance Junction to Case	$\theta_{JC}$			60		° C/W

# **Marking Diagram**

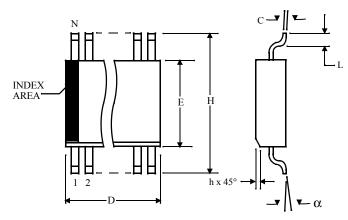


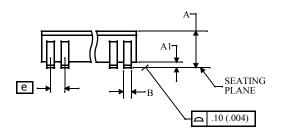
#### Notes:

- 1. ##### is the lot code.
- 2. YYWW is the last two digits of the year, and the week number that the part was assembled.
- 3. Bottom marking: country of origin.

# Package Outline and Package Dimensions (28-pin SOIC, 150 mil Body)

Package dimensions are kept current with JEDEC Publication No. 95, MO-153

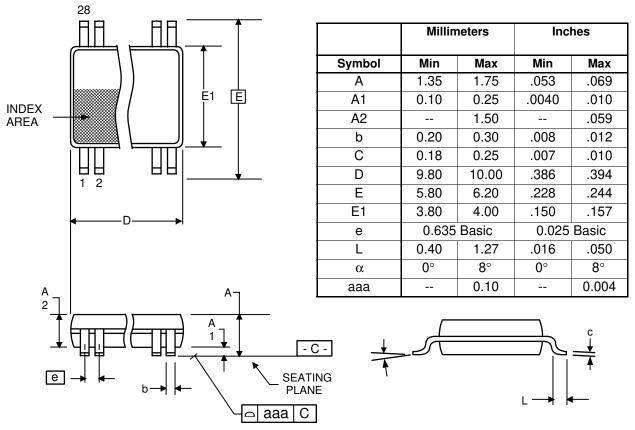




	Millim	neters	Inc	hes	
Symbol	Min Max		Min	Max	
Α		2.65		0.104	
A1	0.10		.0040		
В	0.33	0.51	.013	.020	
С	0.18	0.32	.007	.013	
D	17.70	18.40	.697	.724	
Е	7.40	7.60	.291	.299	
е	1.27	Basic	0.050 Basic		
Н	10.00	10.65	.394	.419	
h	0.25	0.75	.010	.029	
L	0.40	1.27	.016	.050	
α	0°	8°	0°	8°	

### Package Outline and Package Dimensions (28-pin SSOP, 150 mil Body, 0.025 mm Pitch)

Package dimensions are kept current with JEDEC Publication No. 95, MO-153



# **Ordering Information**

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
MK1491-06R	MK1491-06R	Tubes	28-pin SSOP	0 to +70° C
MK1491-06RTR	MK1491-06R	Tape and Reel	28-pin SSOP	0 to +70° C
MK1491-06RLF	MK1491-06RLF	Tubes	28-pin SSOP	0 to +70° C
MK1491-06RLFTR	MK1491-06RLF	Tape and Reel	28-pin SSOP	0 to +70° C
MK1491-06S	MK1491-06S	Tubes	28-pin SOIC	0 to +70° C
MK1491-06STR	MK1491-06S	Tape and Reel	28-pin SOIC	0 to +70° C
MK1491-06SLF	MK1491-06SLF	Tubes	28-pin SOIC	0 to +70° C
MK1491-06SLFTR	MK1491-06SLF	Tape and Reel	28-pin SOIC	0 to +70° C

<sup>&</sup>quot;LF" denotes Pb (lead) free package.

While the information presented herein has been checked for both accuracy and reliability, Integrated Circuit Systems (ICS) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by ICS. ICS reserves the right to change any circuitry or specifications without notice. ICS does not authorize or warrant any ICS product for use in life support devices or critical medical instruments.

## Innovate with IDT and accelerate your future networks. Contact:

www.IDT.com

#### For Sales

800-345-7015 408-284-8200 Fax: 408-284-2775

#### For Tech Support

oduct line email>

#### **Corporate Headquarters**

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road San Jose, CA 95138 United States 800 345 7015 +408 284 8200 (outside U.S.)

#### **Asia Pacific and Japan**

Integrated Device Technology Singapore (1997) Pte. Ltd. Reg. No. 199707558G 435 Orchard Road #20-03 Wisma Atria Singapore 238877 +65 6 887 5505

#### **Europe**

IDT Europe, Limited Prime House Barnett Wood Lane Leatherhead, Surrey United Kingdom KT22 7DE +44 1372 363 339

